



DESDA5V3L

DUAL SURFACE MOUNT TVS ARRAY

Features

- Provides ESD Protection per IEC 61000-4-2 Standard: Air – ±16kV, Contact – ±9kV
- 2 Channels of ESD Protection
- 300 W Peak Pulse Power
- Typically Used at Computers, Printers and Communication Systems
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

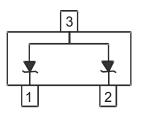
Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 ©3
- Weight: 0.0089 grams (approximate)





Top View



Device Schematic

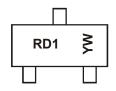
Ordering Information (Note 4)

Part Number	Case	Packaging
DESDA5V3L-7	SOT23	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.

Marking Information



RD1 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: Z = 2012) M = Month (ex: 9 = September)

Date Code Key

Year	2012	2	2013		2014	20	15	2016		2017		2018
Code	Z		Α		В	()	D		Е		F
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P _{PP}	300	W	8/20µs, Fig 2
Peak Pulse Current	IPP	20	Α	8/20μs, Fig 2
ESD Protection – Contact Discharge	V _{ESD_Contact}	±9	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V_{ESD_Air}	±16	kV	Standard IEC 61000-4-2
ESD Protection – Human Body Model	V_{HBM}	±25	kV	MIL STD 883C - Method 3015-6

Thermal Characteristics

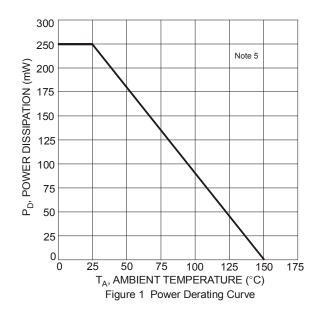
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_{D}	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ hetaJA}$	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

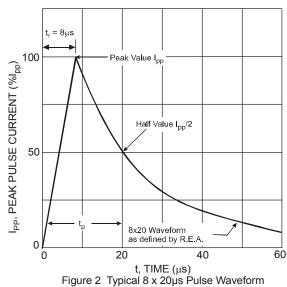
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Breakdown Voltage	V_{BR}	5.3	-	5.9	V	I _R = 1mA
Reverse Current (Note 6)	I_{RM}	-	_	2	μA	V _{RM} = 3V
Forward Voltage	V _F	-	-	1.25	V	I _F = 200mA
Dynamic Resistance	R_D	-	0.28	-	Ω	Ipp = 15A, tp = 2.5µs
Channel Input Capacitance	C _{IN}	-	-	220	pF	V _{IN} = 0V, f = 1MHz

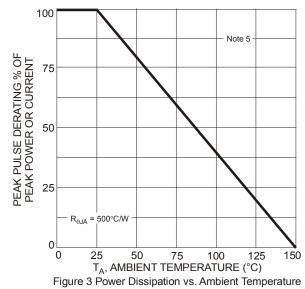
Notes:

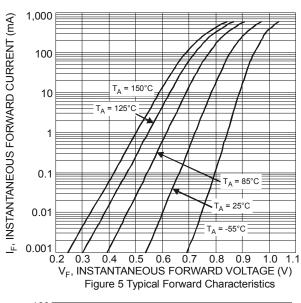
- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.
- 6. Short duration pulse test used to minimize self-heating effect.

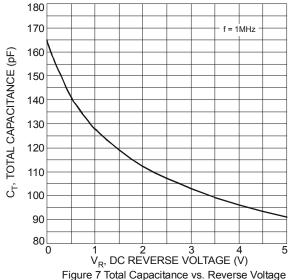












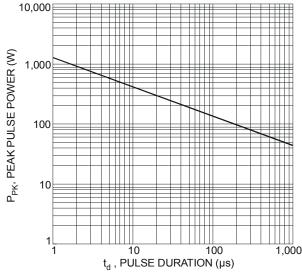
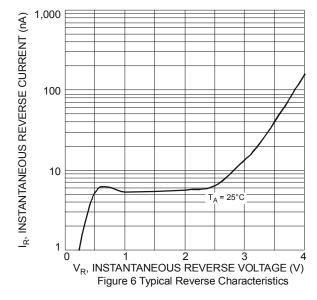


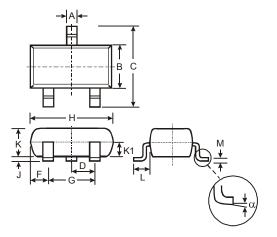
Figure 4 Max. Peak Pulse Power vs. Pulse Duration





Package Outline Dimensions

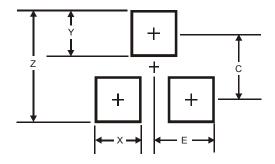
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOT23						
Dim	Min	Max	Тур			
Α	0.37	0.51	0.40			
В	1.20	1.40	1.30			
C	2.30	2.50	2.40			
D	0.89	1.03	0.915			
F	0.45	0.60	0.535			
G	1.78	2.05	1.83			
Η	2.80	3.00	2.90			
J	0.013	0.10	0.05			
K	0.903	1.10	1.00			
K1	-	-	0.400			
L	0.45	0.61	0.55			
М	0.085	0.18	0.11			
α	0°	8°	-			
All	All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.9
Х	0.8
Υ	0.9
С	2.0
Е	1.35



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